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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/921,070	08/02/2001	Joseph C. Barrett	42390.P4934D2	7988

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EXAMINER
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CHU, CHRIS C

ART UNIT	PAPER NUMBER
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2815

DATE MAILED: 11/26/2002

11

Please find below and/or attached an Office communication concerning this application or proceeding.

# Office Action Summary

Application No.

09/921,070

Applicant(s)

BARRETT, JOSEPH C.

Examiner

Chris C. Chu

Art Unit

2815

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

## Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

## Status

- 1) ☒ Responsive to communication(s) filed on 22 May 2000.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

## Disposition of Claims

- 4) ☒ Claim(s) 16 - 42 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) ☐ Claim(s) \_\_\_\_\_ is/are allowed.
- 6) ☒ Claim(s) 16 - 42 is/are rejected.
- 7) ☐ Claim(s) \_\_\_\_\_ is/are objected to.
- 8) ☐ Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

## Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on \_\_\_\_\_ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) ☐ The proposed drawing correction filed on \_\_\_\_\_ is: a) ☐ approved b) ☐ disapproved by the Examiner.
- If approved, corrected drawings are required in reply to this Office action.
- 12) ☐ The oath or declaration is objected to by the Examiner.

## Priority under 35 U.S.C. §§ 119 and 120

- 13) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some \* c) ☐ None of:
- ☐ Certified copies of the priority documents have been received.
  - ☐ Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.
  - ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- \* See the attached detailed Office action for a list of the certified copies not received.
- 14) ☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).
- a) ☐ The translation of the foreign language provisional application has been received.
- 15) ☒ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

## Attachment(s)

- ☒ Notice of References Cited (PTO-892)
- ☒ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- ☒ Information Disclosure Statement(s) (PTO-1449) Paper No(s) 7 and 8.
- ☐ Interview Summary (PTO-413) Paper No(s). \_\_\_\_\_.
- ☐ Notice of Informal Patent Application (PTO-152)
- ☐ Other: \_\_\_\_\_.

## **DETAILED ACTION**

### ***Response to Amendment***

1. Applicant's amendment filed on May 22, 2002 has been received and entered in the case.

### ***Claim Rejections - 35 USC § 102***

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

3. Claims 16, 17, 19, 24 ~ 27, 29 and 34 ~ 37 are rejected under 35 U.S.C. 102(b) as being anticipated by Tokuno.

Regarding claim 16, Tokuno discloses in Figs. 1A and 1C an apparatus comprising:

- a substrate (2);
- a chip (1) mounted on the substrate; and
- a mold cap (15) disposed over the substrate such that the mold cap at least partially covers the chip, the mold cap having an extension extending into a corner section of the substrate.

Art Unit: 2815

Regarding claim 17, Tokuno discloses in Fig. 1A the extension being a rib structure.

Regarding claim 19, Tokuno discloses in Figs. 1A and 1C the extension extending into the corner section of the substrate without extending to an edge of the substrate.

Regarding claim 24, Tokuno discloses in Figs. 1A and 1C an apparatus comprising:

- a substrate (2);
- a chip (1) mounted on the substrate; and
- a mold cap (15) disposed over the substrate such that the mold cap at least partially covers the chip, the mold cap having a plurality of extensions extending into a respective corner section of the substrate.

Regarding claim 25, Tokuno discloses in Fig. 1A the extension being a rib structure.

Regarding claim 26, Tokuno discloses in Fig. 1A each extension being a rounded structure.

Regarding claim 27, Tokuno discloses in Fig. 1A each extension being a rounded corner of the mold cap.

Regarding claim 29, Tokuno discloses in Figs. 1A and 1C at least one extension extending into a respective corner section of the substrate without extending to an edge of the substrate.

Regarding claim 34, Tokuno discloses in Figs. 1A and 1C an apparatus comprising:

- a substrate (2);
- a chip (1) mounted on the substrate; and

Art Unit: 2815

- a mold cap (15) disposed over the substrate such that the mold cap at least partially covers the chip, the mold cap having an extensions adjacent a corner section of the substrate.

Regarding claim 35, Tokuno discloses in Fig. 1A the extension being a rib structure.

Regarding claim 36, Tokuno discloses in Fig. 1A the extension being a rounded structure.

Regarding claim 37, Tokuno discloses in Fig. 1A the extension being a rounded corner of the mold cap.

### ***Claim Rejections - 35 USC § 103***

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

5. Claims 18, 20 ~ 23, 28, 30 ~ 33 and 39 ~ 42 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tokuno in view of Low et al.

Regarding claims 18 and 28, Tokuno discloses the claimed invention except for the extension extending to an edge of the substrate. However, Low et al. discloses in Fig. 4A an extension (408) extending to an edge of a substrate (402). Thus, it would have been obvious to one of ordinary skill in the art at the time when the invention was made to modify Tokuno by using the extension as taught by Low et al. The ordinary artisan would have been motivated to

Art Unit: 2815

modify Tokuno in the manner described above for at least the purpose of being easily removable at the outward extending face (column 7, lines 7 and 8).

Regarding claims 20, 30 and 39, Tokuno discloses the claimed invention except for the mold cap having chamfered edges. However, Low et al. discloses in Fig. 4A a mold cap (404) having chamfered edges (405). Thus, it would have been obvious to one of ordinary skill in the art at the time when the invention was made to modify Tokuno by using the mold cap as taught by Low et al. The ordinary artisan would have been motivated to modify Tokuno in the manner described above for at least the purpose of providing sides of a molded body do not intersect at right angles (column 6, lines 57 and 58).

Regarding claims 21, 31 and 40, Tokuno discloses the claimed invention except for a plurality of solder balls. However, Low et al. discloses in Fig. 1 a plurality of solder balls (108) on a surface of a substrate (106) opposite a mold cap (112). Thus, it would have been obvious to one of ordinary skill in the art at the time when the invention was made to modify Tokuno by using the solder balls as taught by Low et al. The ordinary artisan would have been motivated to modify Tokuno in the manner described above for at least the purpose of providing electrical connection between the semiconductor package and external electronic components (column 1, lines 47 and 48).

Regarding claims 22, 32 and 41, Low et al. discloses in Fig. 1 a plurality of solder balls on the surface of the substrate in an area directly opposite the chip.

Regarding claims 23, 33 and 42, Low et al. discloses in Fig. 1 all solder balls on the surface of the substrate being spaced from areas directly opposite an edge of the chip.

Art Unit: 2815

6. Claim 38 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tokuno in view of Woosley et al.

Tokuno discloses the claimed invention except for the mold cap having a plurality of extensions each adjacent a respective corner section of the substrate. However, Woosley et al. discloses in Fig. 9 the mold cap (54) having a plurality of extensions (the areas of 56) each adjacent a respective corner section of the substrate (14'). Thus, it would have been obvious to one of ordinary skill in the art at the time when the invention was made to modify Tokuno by using the extension as taught by Woosley et al. The ordinary artisan would have been motivated to modify Tokuno in the manner described above for at least the purpose of eliminating voids in the package body (column 2, lines 33 and 34).

### *Conclusion*

7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Iguchi, Sawai, Bigler et al., Murakami, Takahashi and Inoue disclose a semiconductor device.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chris C. Chu whose telephone number is (703) 305-6194. The examiner can normally be reached on M-F (10:30 - 7:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie C. Lee can be reached on (703) 308-1690. The fax phone numbers for the

Art Unit: 2815

organization where this application or proceeding is assigned are (703) 308-7382 for regular communications and (703) 308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Chris C. Chu  
Examiner  
Art Unit 2815

c.c.  
November 22, 2002

A handwritten signature in black ink, appearing to read 'Eddie Lee', with a stylized flourish extending to the right.

EDDIE LEE  
SUPERVISORY PATENT EXAMINER  
TECHNOLOGY CENTER 2800